

"Phase Transformation in Materials"

11.10.2021 Eun Soo Park

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Solidification of Pure Metal

: Thermal gradient dominant



Solidification of single phase alloy: Solute redistribution dominant

1) Equilibrium Solidification : perfect mixing in solid and liquid



Non-equilibrium Solidification I

2) No Diffusion in Solid, Perfect Mixing in Liquid

- : high cooling rate, efficient stirring
 - Separate layers of solid retain their original compositions
 - mean comp. of the solid ($\overline{X_s}$) < X_s



Τ

 T_1

 T_2

 T_3

 \overline{X}_{S}

L

 X_L

3) No Diffusion on Solid, Diffusional Mixing in the Liquid





- Fig. 4.22 Planar front solidification of alloy X₀ in Fig. 4.19 assuming no diffusion in solid and no stirring in the liquid.
- (a) Composition profile when S/L temperature is between T_2 and T_3 in Fig. 4.19.
- X_{ma} (b) Steady-state at T₃. The composition solidifying equals the composition of liquid far ahead of the solid (X_0) .
 - Composition profile at T_E and below, showing (C) the final transient.

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a) Constitutional supercooling

Planar \rightarrow Cellular growth \rightarrow cellular dendritic growth \rightarrow Free dendritic growth

응고계면에 조성적 과냉의 thin zone 형성에 의함 Dome 형태 선단 / 주변에 hexagonal array T↓→ 조성적 과냉영역 증가 Cell 선단의 피라미드형상/ 가지 들의 square array/ Dendrite 성장방향쪽으로 성장방향 변화 성장하는 crystal로 부터 발생한 <u>잠</u> <u>열을 과냉각 액상쪽으로 방출</u>함에 의해 형성 Dendrite 성장 방향/ Branched rod-type dendrite

→ "Nucleation of new crystal in liquid" 성장이 일어나는 interface 보다 높은 온도

b) Segregation

: normal segregation, grain boundary segregation, cellular segregation, dendritic segregation, inversegregation, coring and intercrystalline segregation, gravity segregation

2. Cellular and Dendritic Solidification

Fast Solute diffusion similar to the conduction of latent heat in pure metal, possible to break up the planar front into dendrites.

 \rightarrow complicated, however, by the possibility of temp. gradients in the liquid.



* Constitutional Supercooling

No Diffusion on Solid, Diffusional Mixing in the Liquid

Steady State





Distance $x \rightarrow$

 $\frac{T_{L}' > (T_{1}-T_{3})/(D/v)}{T_{L}' / v < (T_{1}-T_{3})/D}$: Constitutional supercooling \rightarrow cellular/ dendritic growth 8

If temperature gradient ahead of an initially planar interface is gradually reduced below the critical value, (constitutional supercooling at solid/liquid interface)



Fig. 4.24 The breakdown of an initially planar solidification front into cells

If temperature gradient ahead of an initially planar interface is gradually reduced below the critical value, (constitutional supercooling at solid/liquid interface)



(a)

<The breakdown of an initially planar solidification front into cells> ¹⁰

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<The breakdown of an initially planar solidification front into cells> 12

If temperature gradient ahead of an initially planar interface is gradually reduced below the critical value, (constitutional supercooling at solid/liquid interface)



<The breakdown of an initially planar solidification front into cells> 13

Tips of the cells grow into the hottest liquid and therefore contain the least solute.



* Temp. and solute distributions associated with cellular solidification.

1) Note that solute enrichment in the liquid between the cells, and coring in the cells with eutectic in the cell walls.





2) Tips of the cells grow into the hottest liquid and therefore contain the least solute.

3) Even if $X_0 << X_{max}$ Solute file up \rightarrow eutectic solidification

 \rightarrow formation of 2nd phases at the cell wall



The change in morphology from cells to dendrites

- * Cellular microstructures are only stable for a certain range of temp. gradients.
- → Sufficiently low temp. gradients → Creation of constitutional supercooling in the liquid between the cells causing interface instabilities in the transverse direction (although, No temp. gradient perpendicular to the growth direction)
- → Develop arms, i.e. dendrites form & Change in the direction of the primary arms away from the direction of heat flow into the crystallographically preferred directions i.e. (100) for cubic metals.



Fig. 4.27 Cellular dendrites in carbon tetrabromide. (After L.R. Morris and W.C. Winegard, Journal of Crystal Growth 6 (1969) 61.)



Fig. 4.28 Columnar dendrites in a transparent organic alloy.

(After K.A. Jackson in Solidification, American Society for Metals, 1971, p. 121.)

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Solidification: Liquid ----- Solid

< Nucleation >

• Nucleation in Pure Metals

- < Growth >
- Equilibrium Shape and Interface Structure on an Atomic Scale
- Growth of a pure solid
- Heat Flow and Interface Stability

4.3 Alloy solidification

- Solidification of single-phase alloys
- Eutectic solidification
- Off-eutectic alloys
- Peritectic solidification

Q: Various different types of eutectic solidification $(L \rightarrow \alpha + \beta)$?





various Schematic representation possible in eutectic structures. (a), (b) and (c) are Fig. 14 alloys shown in fig. 13; (d) nodular; (e) Chinese script; (f) acicular; (g) lamellar; and (h) divorced.

4.3.2 Eutectic Solidification

Various different types of eutectic solidification \rightarrow Both phases grow simultaneously.

Normal eutectic

both phases have low entropies of fusion.



Fig. 4.30 Rod-like eutectic. Al₆Fe rods in Al matrix. Transverse section. Transmission electron micrograph (x 70000).

Anomalous eutectic One of the solid phases is capable of faceting, i.e., has a high entropy or melting.



The microstructure of the Pb-61.9%Sn (eutectic) alloy presented a coupled growth of the (Pb)/ β Sn eutectic. There is a remarkable change in morphology increasing the degree of undercooling with transition from regular lamellar to anomalous eutectic. 21

Eutectic

Divorced Eutectic





Q: Thermodynamics and Kinetics of eutectic solidification $(L \rightarrow \alpha + \beta)$?

This section will only be concerned with normal structures, and deal mainly with lamellar morphologies.





Plot the diagram of Gibbs free energy vs. composition at T_3 and T_4 .

What is the driving force for the eutectic reaction (L $\rightarrow \alpha$ + β) at T₄ at C_{eut}?

What is the driving force for nucleation of α and β ? " ΔT "

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Eutectic Solidification (Kinetics)

: $\Delta T \rightarrow$ formation of interface + solute redistribution

If α is nucleated from liquid and starts to grow, what would be the composition at the <u>interface</u> of α /L determined?

 \rightarrow rough interface (diffusion interface) & local equilibrium

How about at β/L ? Nature's choice? Lamellar structure

$$\rightarrow$$
 G = **G**_{bulk} + **G**_{interface} = **G**₀ + γ **A**

 $\sum A_i \gamma_i + \Delta G_s = minimum$ Interface energy + Misfit strain energy



What would be a role of the <u>curvature</u> at the tip?

→ Gibbs-Thomson Effect





 $\lambda^* = -\frac{2T_E\gamma V_m}{\lambda \mu \Lambda \tau} \rightarrow identical to critical radius$ of dendrite tip in pure metal

Gibbs-Thomson effect

$$cf) r^{*} = \frac{2\gamma_{SL}}{\Delta G_{V}} = \left(\frac{2\gamma_{SL}T_{m}}{L_{V}}\right)\frac{1}{\Delta T}$$

 L_{v} : latent heat per unit volume $/ = \Delta H = H^{L} - H^{S}$

* Growth Mechanism: Gibbs-Thomson effect in a △G-composition diagram?



The cause of G increase is the curvature of the α/L and β/L interfaces arising from the need to balance the interfacial tensions at the $\alpha/\beta/L$ triple point, therefore the increase will be different for the two phases, but for simple cases it can be shown to be

 $\frac{2\gamma_{\alpha\beta}V_{\rm m}}{2}$ for both.

1) If $\lambda = \lambda^*$, growth rate will be <u>infinitely</u> <u>slow</u> because the liquid in contact with both phases has the same composition, X_{F} in Figure 4.32.



^{D)} Fig. 4.33 (a) Molar free energy diagram at $(T_E - \Delta T_0)$ for the case $\lambda^* < \lambda < \infty$, showing the composition difference available to drive diffusion through the liquid 28 (ΔX). (b) Model used to calculate the growth rate.





between ΔX and ΔX_0 (exaggerated for clarity)



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Closer look at the tip of a growing dendrite

different from a planar interface because heat can be conducted away from the tip in three dimensions.



$$T'_{L}(negative) \cong \frac{\Delta T_{C}}{r} \quad \Delta T_{C} = T_{i} - T_{\infty}$$

$$v = \frac{-K_{L}T'_{L}}{L_{V}} \cong \frac{K_{L}}{L_{V}} \cdot \frac{\Delta T_{C}}{r} \quad v \propto \frac{1}{r}$$

Thermodynamics at the tip?

Gibbs-Thomson effect: melting point depression



$$\Delta G = \frac{L_V}{T_m} \Delta T_r = \frac{2\gamma}{r} \qquad \Delta T_r = \frac{2\gamma T_m}{L_V r_{31}}$$



Undercooling ΔT_0



Fig. 4.34 Eutectic phase diagram showing the relationship between ΔX and ΔX_0 (exaggerated for clarity)

Undercooling ΔT_0

$$\Delta T_{0} = \Delta T_{r} + \Delta T_{D} \implies \Delta G_{total} = \Delta G_{r} + \Delta G_{D} \implies v = k_{2}D\frac{\Delta T_{0}}{\lambda}(1 - \frac{\lambda^{*}}{\lambda})$$
Curvature Composition gradient
$$\Delta G_{r} = \frac{2\gamma_{\alpha \gamma}V_{m}}{\lambda} \implies \Delta G_{D} \rightarrow \text{free energy dissipated in diffusion}$$
By varying the interface undercooling (ΔT_{0}) it is possible to vary the growth rate (ν) and spacing (λ) independently.
Therefore, it is impossible to predict the spacing that will be observed for a given growth rate. However, controlled growth experiments show that a specific value of λ is always

* For example,

Maximum growth rate at a fixed $\Delta T_0 \rightarrow \lambda_0 = 2\lambda^*$ (4) $v = k_2 D \frac{\Delta T_0}{\lambda} (1 - \frac{\lambda^*}{\lambda}) \implies v_0 = k_2 D \Delta T_0 / 4 \lambda^*$ (5) From Eq. 4.39 $\lambda^* = + \frac{2T_E \gamma V_m}{\Delta H \Delta T_0} \implies \Delta T_0 \propto 1 / \lambda^*$ (6) So that the following Ex) Lamellar eutectic in the Pb-Sn system $v_0 \lambda_0^2 = k_3$ (constant) relationships are predicted: $k_{3} \sim 33 \ \mu m^{3}/s$ and $k_{4} \sim 1 \ \mu m/s \cdot K^{2}$ (5) + (6) $\frac{v_0}{\left(\Delta T_0\right)^2} = k_4$ $\rightarrow v = 1 \ \mu m/s, \lambda_0 = 5 \ \mu m$ and $\Delta T_0 = 1 \ K$ 34

associated with a given growth rate.

* Total Undercooling

 $\Delta T_0 = \Delta T_r + \Delta T_D$

Undercooling required to overcome the interfacial curvature effects

Strictly speaking,

 ΔT_i term should be added but, negligible for high mobility interfaces

Driving force for atom migration across the interfaces

Undercooling required to give a sufficient composition difference to drive the diffusion

* A planar eutectic front is not always stable.

Binary eutectic alloys contains impurities or other alloying elements "Form a cellular morphology"

 analogous to single phase solidification restrict in a sufficiently high temp. gradient.

- The solidification direction changes as the cell walls are approached and the lamellar or rod structure fans out and may even change to an irregular structure.
- Impurity elements (here, mainly copper) concentrate at the cell walls.



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Fig. 4.35 Transverse section through the cellular structure of an Al-Al $_6$ Fe rod eutectic (x3500).


Q: Off-eutectic Solidification?

4.3.3 Off-eutectic Solidification _Pb-Sn system



FIGURE 10-12 The solidification and microstructure of a hypoeutectic alloy (Pb-30% Sn).

4.3.3 Off-eutectic Solidification _Pb-Sn system



FIGURE 10-13 (a) A hypoeutectic lead-tin alloy. (b) A hypereutectic lead-tin alloy. The dark constituent is the lead-rich solid α , the light constituent is the tin-rich solid β , and the fine plate structure is the eutectic (× 400).

4.3.3 Off-eutectic Solidification



Q: Peritectic Solidification $(L + \alpha \rightarrow \beta)$?

Solidification and microstructure

that develop as a result of the peritectic reaction



4.3.4 Peritectic Solidification



-

Solidification: Liquid ----- Solid

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 - < Growth >
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b) Segregation

: normal segregation, grain boundary segregation, cellular segregation, dendritic segregation, inversegregation, coring and intercrystalline segregation, gravity segregation Two of the most important application of solidification : "Casting" and "Weld solidification"

Q: What kinds of ingot structure exist?

Ingot Structure

- Chill zone
- Columnar zone
- Equiaxed zone

4.4 Solidification of Ingots and Castings

a lump of metal, usually shaped like a brick.

an object or piece of machinery which has been made by pouring a liquid such as hot metal into a container

Later to be worked, e.g. by rolling, extrusion or forging>> blank (small)

Permitted to regain their shape afterwards, or reshaped by machining

Ingot Structure

- outer Chill zone
 - : equiaxed crystals
- Columnar zone
 - : elongated or column-like grains
- central Equiaxed zone

Chill zone



- Solid nuclei form on the mould wall and begin to grow into the liquid.

- If the pouring temp. is low: liquid~ rapidly cooled below the liquidus temp. → big-bang nucleation → entirely equiaxed ingot structure, no columnar zone
- 2) If the pouring temp. is high: liquid~remain above the liquidus temp. for a long time → majority of crystals~remelt under influence of the turbulent melt ("convection current") → form the chill zone

Columnar zone

After pouring the temperature gradient at the mould walls decreases and the crystals in the chill zone grow dendritically in certain crystallographic directions, e.g. <100> in the case of cubic metals.

 \rightarrow grow fastest and outgrow less favorably oriented neighbors



Fig. 4.41 Competitive growth soon after pouring. <u>Dendrites with primary arms</u> <u>normal to the mould wall</u>, i.e. parallel to the maximum temperature gradient, outgrow less favorably oriented neighbors. Fig. 4.42 Favorably oriented dendrites develop into columnar grains. Each columnar grain originates from the same heterogeneous nucleation site, but can contain many primary dendrite arms.

- 1) In general, the secondary arms become coarser with distance behind the primary dendrite tips.
- 2) The primary and secondary dendrite arm spacing increase with increasing distance from the mold wall.
 (∵ a corresponding decrease in the cooling rate with time after pouring)

Mushy zone (or pasty zone) depends on temp. gradient and nonequil. freezing range of the alloy



Fig. 4.28 Columnar dendrites in a transparent organic alloy.

(After K.A. Jackson in Solidification, American Society for Metals, 1971, p. 121.)

Equiaxed zone

The equiaxed zone consists of equiaxed grains randomly oriented in the centre of the ingot. An important origin of these grains is thought to be <u>melted-off dendrite side-arms + convection current</u>



Fig. 4.40Schematic cast grain structure.(After M.C. Flemings, Solidification Processing, McGraw-Hill, New York, 1974.)9



Q: What kind of segregations exist?

4.4.2 Segregation and Shrinkage in Ingots and Castings

(a) Segregation

- Macrosegregation : Large area composition changes over distances comparable to the size of the specimen.
- Microsegregation: In the secondary dendrite arm occur on the scale of the secondary dendrite arm spacing.

Four important factors that can lead to macrosegregation

- a) Shrinkage due to solidification and thermal contraction.
- b) Density differences in the interdendritic liquid.
- c) Density differences between the solid and liquid.
- d) Convection currents driven by temperature-induced density differences in the liquid.

Fig. Simulation of macrosegregation formation in a large steel casting, showing liquid velocity vectors during solidification (left) and final carbon macrosegregation pattern (right).



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Fig.

Freckles in a single-crystal nickel-based superalloy prototype blade (left) and closeup of a <u>single freckle (right)</u> (courtesy of A. F. Giamei, United Technologies Research Center).



Fig.

Sulfur print showing centerline segregation in a continuously cast steel slab (courtesy of IPSCO Inc.).





The result obtained by APT analysis. (a) 3D Atom map of **Boron steel containing 100 ppm Boron** and (b) composition profile showing **solute segregation within**₁₆ **retained austenite and grain boundary** *Korean J. Microscopy Vol. 41, No. 2, 2011*

0

G.B.

Boron

* **Segregation**: undesiable ~ deleterious effects on mechanical properties

 \rightarrow subsequent homogenization heat treatment, but diffusion in the solid far to slow

→ good control of the solidification process



Inverse segregation (역편석): As the columnar dendrites thicken soluterich liquid (assuming k<1) must flow back between the dendrites to compensate for (a) shrinkage and this raises the solute content of the outer parts of the ingot relative to the center.

EX) Al-Cu and Cu-Sn alloys with a wide freezing range (relatively low k)

Negative segregation: The solid is usually denser than the liquid and sinks carrying with it less solute (초 기응고고상)than the bulk composition (assuming k<1). This can, therefore, lead to a region of negative segregation near the bottom of the ingot. ((b) Gravity effects)

Fig. 4.43 Segregation pattern in a large killed steel ingot. + positive, - negative segregation. (After M.C. Flemings, Scandinavian Journal of Metallurgy 5 (1976) 1.) 17

Q: Shrinkage in Solidification and Cooling?

(b) Shrinkage

Crystallization is Controlled by Thermodynamics

Volume

- Volume is high as a hot liquid
- Volume shrinks as liquid is cooled
- At the melting point, T_m, the liquid crystallizes to the thermodynamically stable crystalline phase
- More compact (generally) crystalline phase has a smaller volume
- The crystal then shrinks as it is further cooled to room temperature
- Slope of the cooling curve for liquid and solid is the thermal expansion coefficient, α



Shrinkage in Solidification and Cooling



* Shrinkage of a cylindrical casting during solidification and cooling:
 (0) starting level of molten metal immediately after pouring; (1) reduction in level caused by liquid contraction during cooling (dimensional reductions are exaggerated for clarity).

Shrinkage in Solidification and Cooling



* (2) reduction in height and formation of shrinkage cavity caused by solidification shrinkage; (3) further reduction in height and diameter due to thermal contraction during cooling of solid metal (dimensional reductions are exaggerated for clarity).

Shrinkage effect

* Formation of Voids during solidification



Shrinkage in Solidification and Cooling

- Can amount to 5-10% by volume
- Gray cast iron expands upon solidification due to phase changes
- Need to design part and mold to take this amount into consideration

Metal or alloy	Volumetric solidification contraction (%)	Metal or alloy	Volumetric solidification contraction (%)
Aluminum	6.6	70%Cu-30%Zn	4.5
Al-4.5%Cu	6.3	90%Cu-10%Al	4
Al-12%Si	3.8	Gray iron	Expansion to 2.5
Carbon steel	2.5-3	Magnesium	4.2
1% carbon steel	4	White iron	4-5.5
Copper	4.9	Zinc	6.5

Source: After R. A. Flinn.

TABLE 51

* Volumetric solidification expansion: H₂O (10%), Si (20%), Ge

ex) Al-Si eutectic alloy (casting alloy)→ volumetric solidification contraction of Al substitutes volumetric solidification expansion of Si.

Cast Iron: Fe + Carbon (~ 4%) + Si (~2%)

 \rightarrow precipitation of graphite during solidification reduces shrinkage.

Q: What is continuous casting?

4.4.3 continuous casting: a number of dynamic industrial process

The molten metal is poured continuously into a water-cooled mold from which the solidified metal is continuously withdrawn in plate or rod form. (solid-liquid interface)



"Dynamic process: importance of isotherm distribution"



Fig. 4.44 Schematic illustration of a continuous casting process

Fig. 4.45 Illustrating the essential equivalence of isotherms aboutthe heat sources in fusion welding and continuous casting26

4.4.3 continuous casting

AT W

4.4.3 continuous casting


4.4.3 continuous casting



Q: Glass formation?

4.6 Solidification during Quenching from the Melt

Time-Temperature-Transformation diagram



Electrostatic Levitation: cooling curve of Vitreloy 1 system



Structure of Crystals, Liquids and Glasses

Crystals

Liquids, glasses





Building block: arranged in orderly, 3-dimensional, periodic array

grain boundaries

nearly random = non-periodic

no grain boundaries

Glass Formation is Controlled by Kinetics

Molar Volume

- Glass forming liquids are those that are able to "by-pass" the melting point, T_m
- Liquid may have a high viscosity that makes it difficult for atoms of the liquid to diffuse (rearrange) into the crystalline structure
- Liquid maybe cooled so fast that it does not have enough time to crystallize
- Two time scales are present
 - "Internal" time scale controlled by the viscosity (bonding) of the liquid
 - "External" timescale controlled by the cooling rate of the liquid



Temperature

The Cooling Rate Affects the Properties of Glass

- Faster cooling freezes in the glass at a higher temperature
- The temperature is lowered so fast that the liquid does not have time to relax to the properties at the next lower temperature, glass is formed at a high temperature
- Slower cooling freezes in the glass at a lower temperature
- The temperature is lowered slowly enough that the liquids can relax to properties at lower and lower temperatures, glass is eventually formed at a lower temperature



Temperature

Fundamentals of the Glass Transition

Melting and Crystallization are • The Glass Transition is • **Thermodynamic Transitions**

Volume

a Kinetic Transition



Schematic of the glass transition showing the effects of temperature on free energy





Schematic of the glass transition showing the effects of temperature on the entropy, viscosity, specific heat, and free energy. T_x is the crystallization onset temperature.

Glass formation : (1) Fast Cooling



Glass formation : (2) Better Glass Former



Glass formation : stabilizing the liquid phase

First metallic glass (Au₈₀Si₂₀) produced by splat quenching at Caltech by Pol Duwez in 1960.



W. Klement, R.H. Willens, P. Duwez, Nature 1960; 187: 869.

Glass formation: Rapid quenching (~10⁵⁻⁶ K/s) of liquid phase

1969 Ribbon type with long length using melt spinner : FePC, FeNiPB alloy



Recent BMGs with critical size ≥ 10 mm



A.L. Greer, E. Ma, MRS Bulletin, 2007; 32: 612.43

Bulk glass formation in the Pd-/Ni-/Cu-/Zr- element system

Massy Ingot Shape

(a) Pd-Cu-Ni-P



72 px 75 mm 80 px 85 mm



Cylindrical Rods

(e) Pd-Cu-Ni-P

(f) Pt-Pd-Cu-P



Hollow Pipes (g) Pd-Cu-Ni-P



Recent BMGs with critical size ≥ 10 mm



Q: BMG = The 3rd Revolution in Materials?

The 3rd Revolution in Materials



1. High strength of BMGs



High fracture strength over 5 GPa in Fe-based BMGs

A.L. Greer, E. Ma, MRS Bulletin, 2007; 32: 612.

2. Large elastic strain limit of BMGs



2. Large elastic strain limit of BMGs



Metallic Glasses Offer

a Unique Combination of "High Strength" and "High Elastic Limit"



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* Thermoplastic forming in SCLR



Metallic glass can be processed like plastics by homogeneous Newtonian viscous flow in supercooled liquid region (SCLR).

Possible to deform thin and uniform in SCLR



Precision Gears for Micro-motors



Precision die casting





MRS BULLETIN 32 (2007)654.



Micro-forming of three-dimensional microstructures from thin-film metallic glass



* Thermoplastic forming in SCLR

Mg₆₅Cu₂₅Gd₁₀ metallic glass ribbon



► Drawing sample at 220°C → Elongation over 1100%



Seamaster Planet Ocean Liquidmetal® Limited Edition

Superior thermo-plastic formability

: possible to fabricate complex structure without joints

- Multistep processing can be solved by simple casting
- Ideal for small expensive IT equipment manufacturing



ADVANCED MATERIALS

Processing of Bulk Metallic Glass

Adv. Mater. 2009, 21, 1–32



"Yale professor makes the case for Supercool Metals"



According to Yale researcher Jan Schroers, This material is 50 times harder than plastic, nearly 10 times harder than aluminum and almost three times the hardness of steel."











Enclosure / Antenna

Apple continuing work on Liquidmetal casting techniques...

October 29, 2015

Two New Liquid Metal Inventions Published Today Cover Every Current Apple Product and even Complete Car Panels



Apple's patents cover the use of liquid metal in <u>every imaginable Apple product</u> and even hints that the process described in these inventions could produce complete car panels. That makes you wonder if Apple's Project Titan will be able to take advantage of the liquid metal process for car parts and beyond.

First smart phone with BMG exterior

Turing phone by Turing Robotics Industries (UK)

with

Metallic glass "Liquidmorphium™"





"Unhackable" "Waterproof" +

"Unbreakable"

The Turing Phone is built with a pioneering material called Liquidmorphium[™], an amorphous "liquid metal" alloy tougher than either titanium or steel - so what's in your hand is as strong as your privacy protection.

from https://www.turingphone.com/

A new menu of engineering materials



A new menu of engineering materials



Skip section 4.5 and 4.8 in the text book

* Homework 4 : Exercises 4 (pages 257-259) until 2nd exam

Good Luck!!